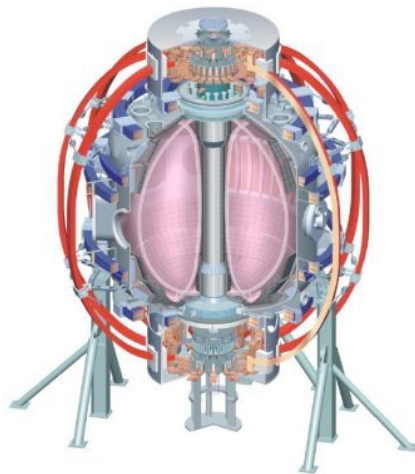


# Center Stack Upgrade Diagnostics

**R. Kaita**

**NSTX Centerstack Upgrade Peer Review  
LSB, B318  
April 29, 2010**

College W&M  
Colorado Sch Mines  
Columbia U  
CompX  
General Atomics  
INEL  
Johns Hopkins U  
LANL  
LLNL  
Lodestar  
MIT  
Nova Photonics  
New York U  
Old Dominion U  
ORNL  
PPPL  
PSI  
Princeton U  
Purdue U  
SNL  
Think Tank, Inc.  
UC Davis  
UC Irvine  
UCLA  
UCSD  
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U Illinois  
U Maryland  
U Rochester  
U Washington  
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Culham Sci Ctr  
U St. Andrews  
York U  
Chubu U  
Fukui U  
Hiroshima U  
Hyogo U  
Kyoto U  
Kyushu U  
Kyushu Tokai U  
NIFS  
Niigata U  
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JAEA  
Hebrew U  
Ioffe Inst  
RRC Kurchatov Inst  
TRINITI  
KBSI  
KAIST  
POSTECH  
ASIPP  
ENEA, Frascati  
CEA, Cadarache  
IPP, Jülich  
IPP, Garching  
ASCR, Czech Rep  
U Quebec

# Scope of Center Stack Diagnostics

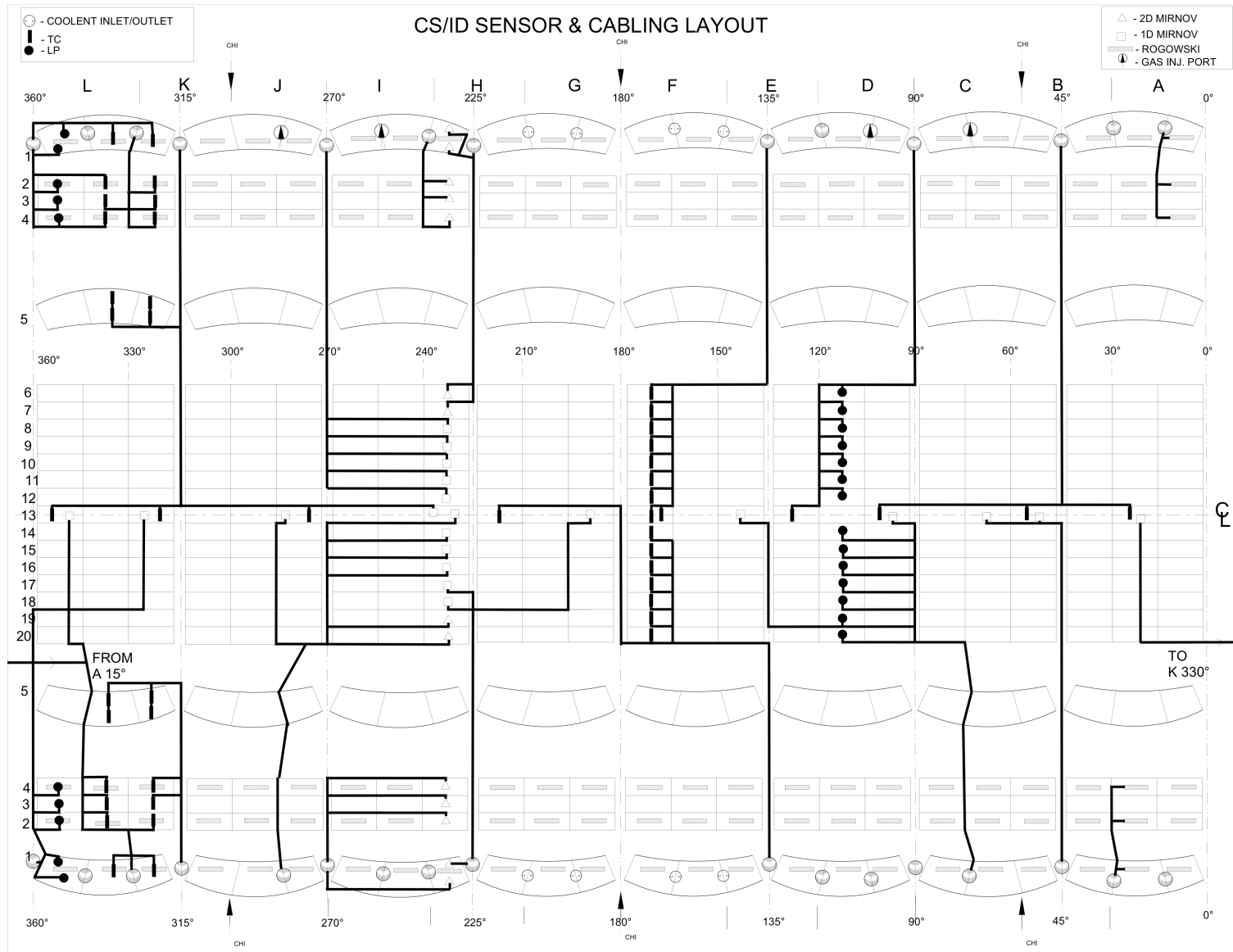
## I. Inside Plasma-Facing Components

- 1) Thermocouples
- 2) Mirnov/Pickup Coils
- 3) Halo Current Rogowski Coils
- 4) Tile-mounted Langmuir Probes

## II. Around OH Ground Plane

- 1) Plasma Current Rogowski Coils
- 2) Flux Loops

# Thermocouple, Mirnov coil, halo current Rogowski coil, and Langmuir probe locations close to finalized



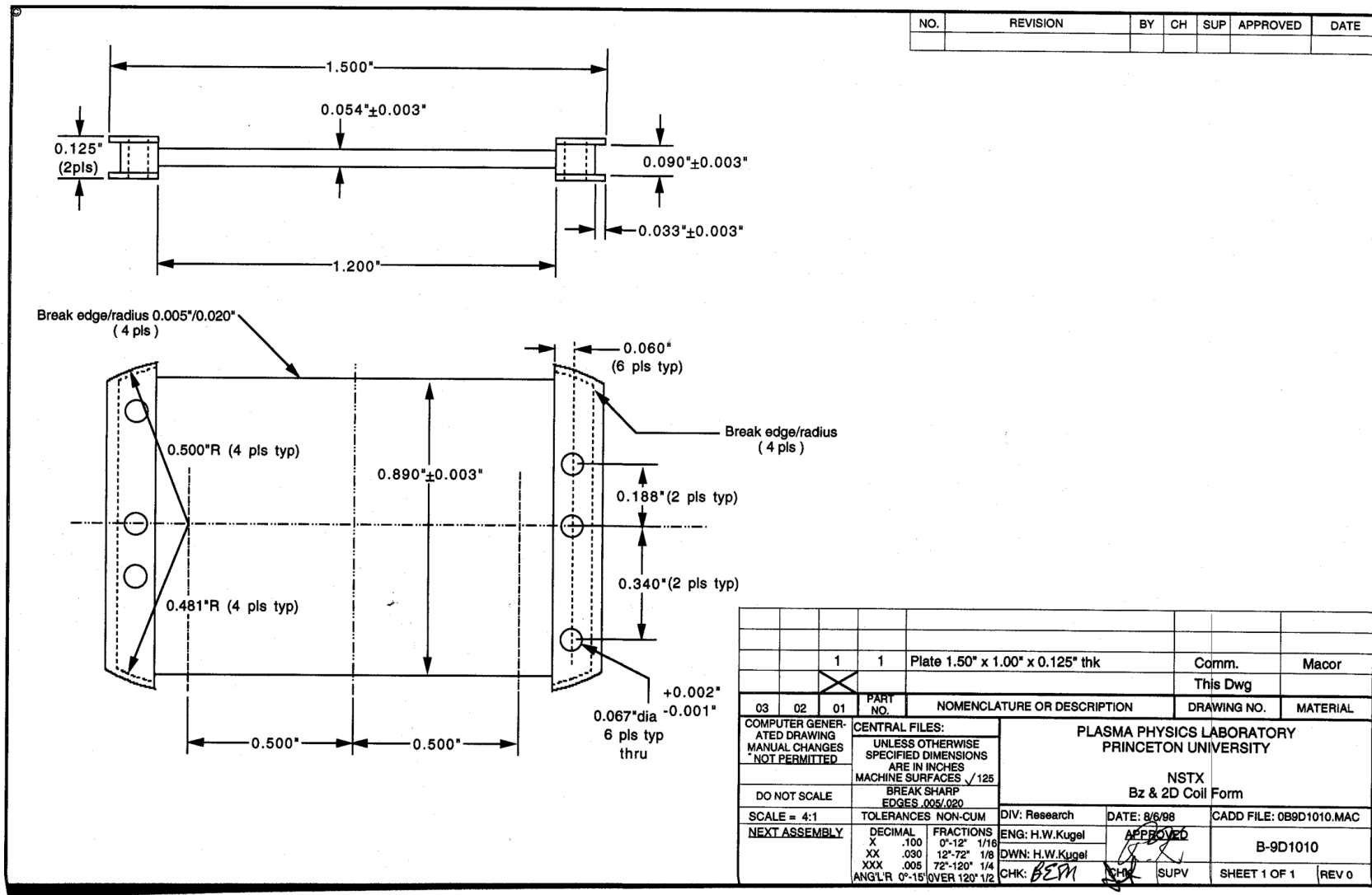
# Thermocouple Summary

- Status
  - Locations
    - Specified in detail since August 13, 2009 peer review
  - Design
    - Unchanged
  - Documentation
    - Installation procedure needs modification to accommodate new tile design (channels for cable routing and means for securing to tiles)
  - Impact of upgrade on diagnostic
    - No temperature issues: Nextel insulation rated to 1375 °C continuous
    - No mechanical issues: Wires held in place by tiles

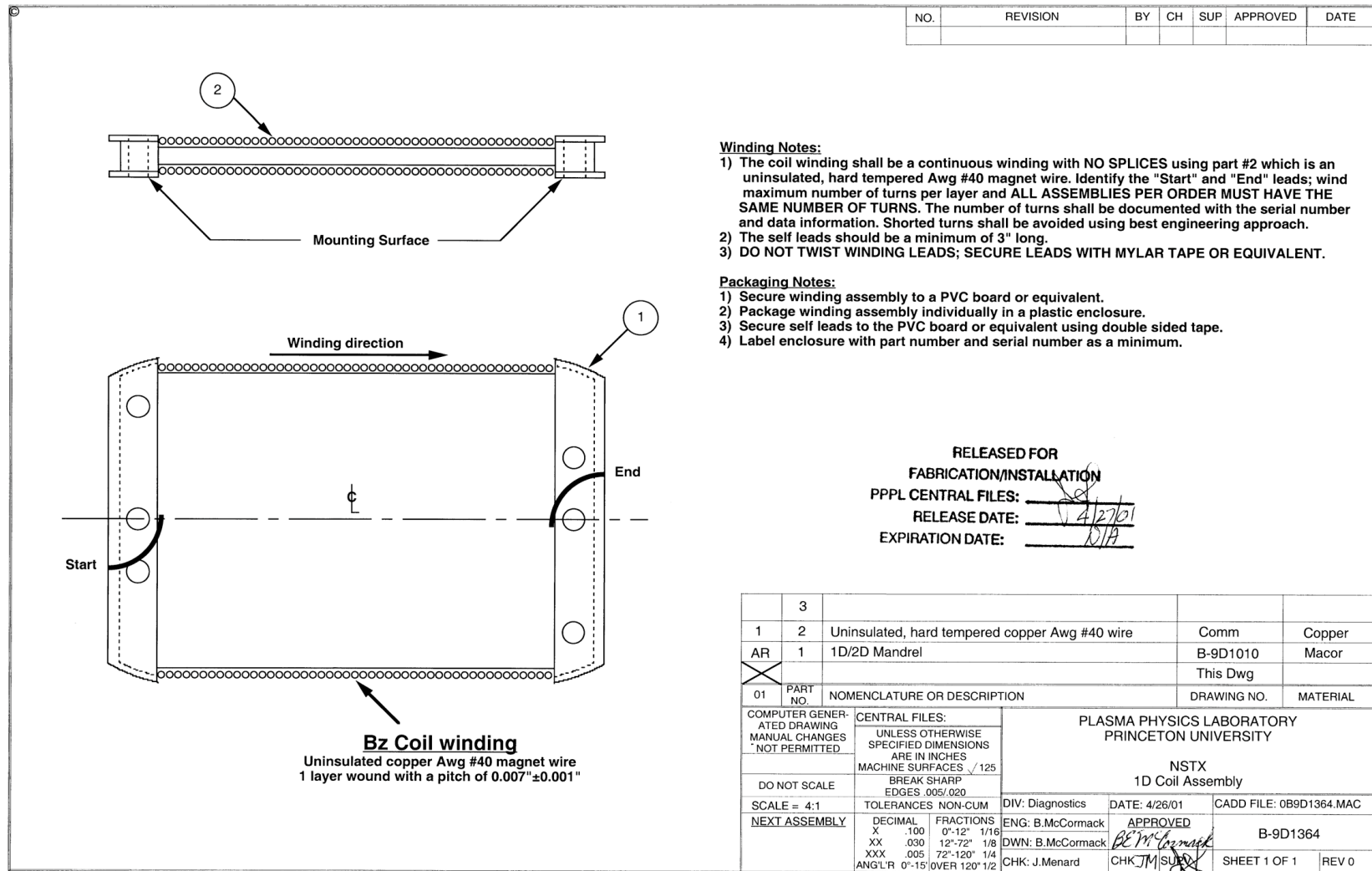
# Mirnov/Pickup Coil Summary

- Status
  - Locations
    - Specified in detail since August 13, 2009 peer review
  - Design
    - Essentially unchanged
    - Slightly larger tiles may mean mandrels could be enlarged and simplified for ease of fabrication
  - Documentation
    - Drawings available from archived NSTX engineering drawings
      - Machinist on main campus unavailable for fabrication of 35 mandrels
      - Awaiting response from Zenex about interest in bidding for job
    - Statement of Work for winding available (Airex Corporation)
    - Installation procedure needs modification to accommodate new tile design (channels for cable routing and means for securing heavier gauge cables to sensors)

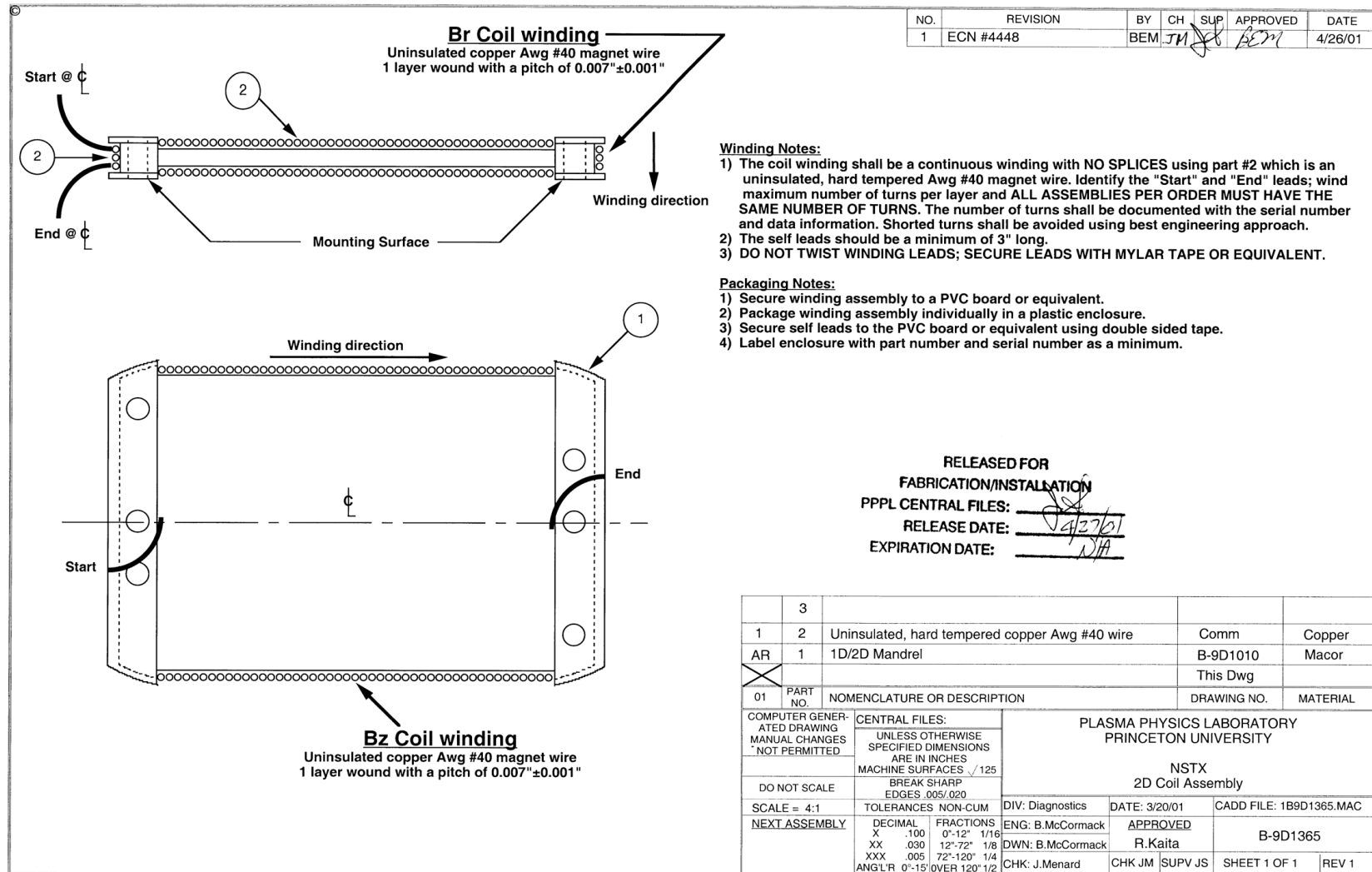
# Mirnov Coil Mandrel Fabrication Drawing



# 1D Mirnov Coil Winding Drawing



# 2D Mirnov Coil Winding Drawing





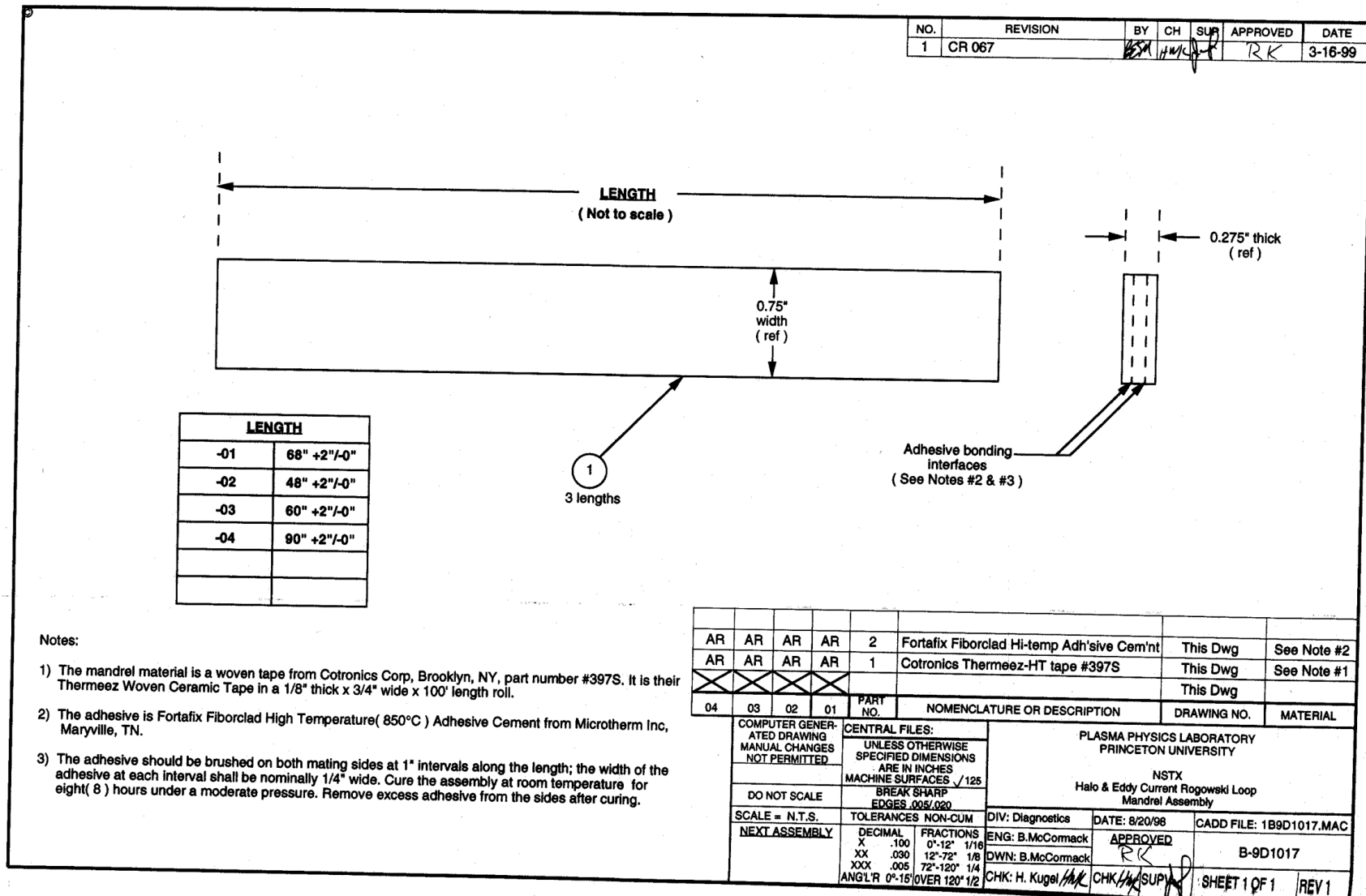
## Mirnov/Pickup Coil Summary (continued)

- Status (continued)
  - Impact of upgrade on diagnostic
    - No temperature issues:
      - Bare copper wire melts at 1083 °C
      - Wound on MACOR mandrel rated at 800 °C continuous
      - “Potted” with Fortafix high temperature adhesive with maximum rating of 850 °C
    - No mechanical issues: Sensors and wires held in place by tiles

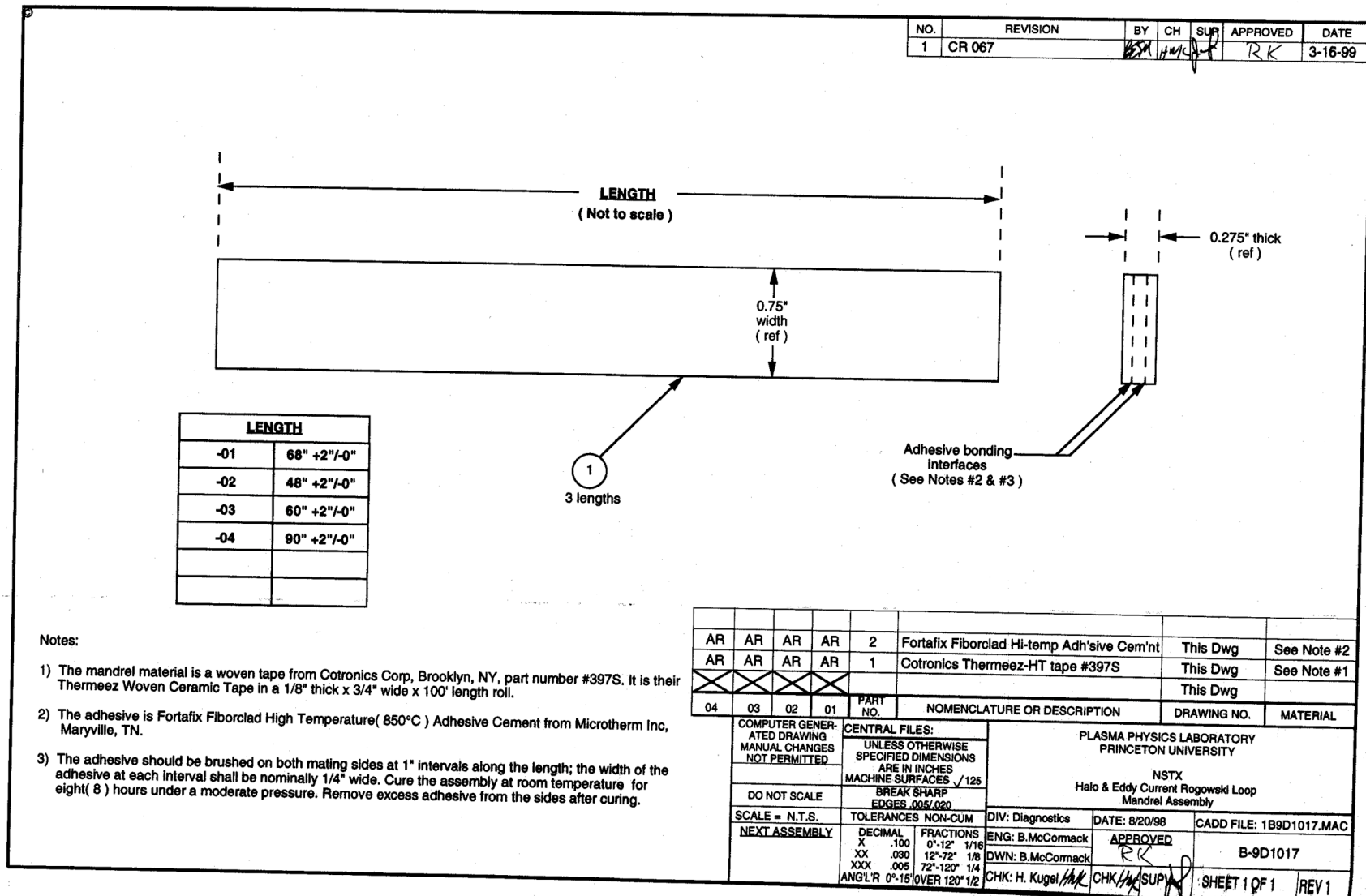
# Halo Current Rogowski Coil Summary

- Summary
  - Locations
    - Specified in detail since August 13, 2009 peer review
    - Includes additional coils in “horizontal” sections of divertor regions
  - Design
    - Essentially unchanged for “vertical sections”
    - May need to change width for “horizontal” sections (depending on tile thickness)
  - Documentation
    - Drawings available from archived NSTX engineering drawings
    - Statement of Work for winding available (Airex Corporation)
    - Installation procedure needs modification to accommodate new tile design (channels for cable routing and means for securing heavier gauge cables to sensors)

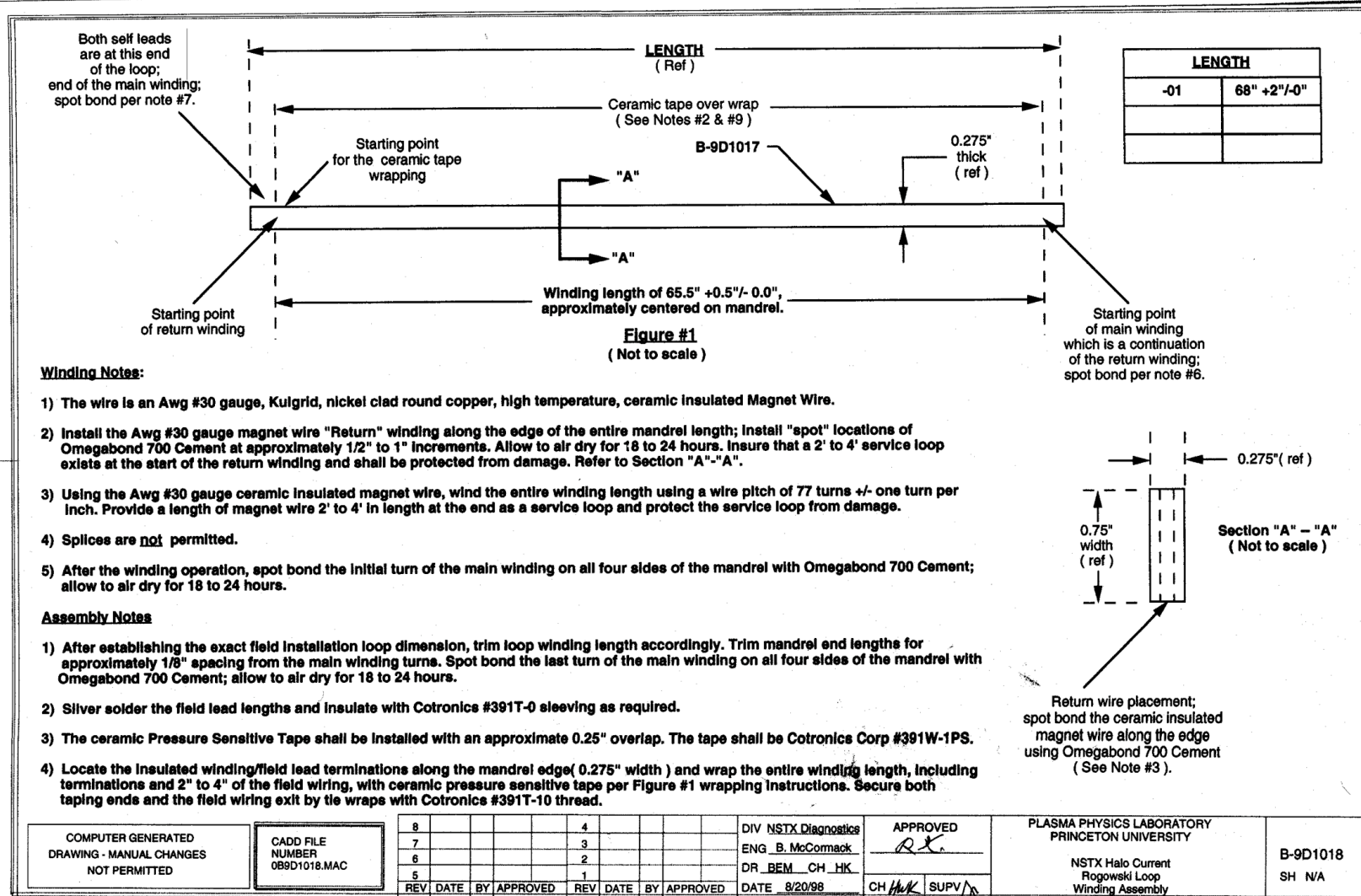
# Halo Current Rogowski Mandrel Drawing



# Halo Current Rogowski Mandrel Drawing



# Halo Current Rogowski Winding Drawing



## Halo Current Rogowski Coil Summary (continued)

- Status (continued)
  - Remaining space allocation task
    - Halo current Rogowski coil requested on center stack midplane
      - Does not exist on present center stack
      - Planned space is 1" x 0.25" deep
        - » Need to determine if coil can be reduced from present thickness of 0.275" for mandrel plus wire and "potting"
    - No mechanical issues: Sensors and wires held in place by tiles
  - Impact of upgrade on diagnostic
    - No temperature issues:
      - Bare copper wire melts at 1083 °C
      - Wound on Cotronics ceramic woven tape mandrel rated at 1650 °C
      - "Potted" with Fortafix high temperature adhesive with maximum rating of 850 °C
    - No mechanical issues: Sensors and wires held in place by tiles

# Langmuir Probe Summary

- Summary
  - Locations
    - Specified in detail since August 13, 2009 peer review
  - Design
    - Unchanged
    - Keeping present center stack arrangement of one sensor per tile
  - Documentation
    - Probe tip fabrication drawings available
    - Standard tile drawings need modification to accommodate probe tips
    - Installation procedure needs modification to accommodate new tile design (channels for cable routing and means for securing heavier gauge cables to sensors)





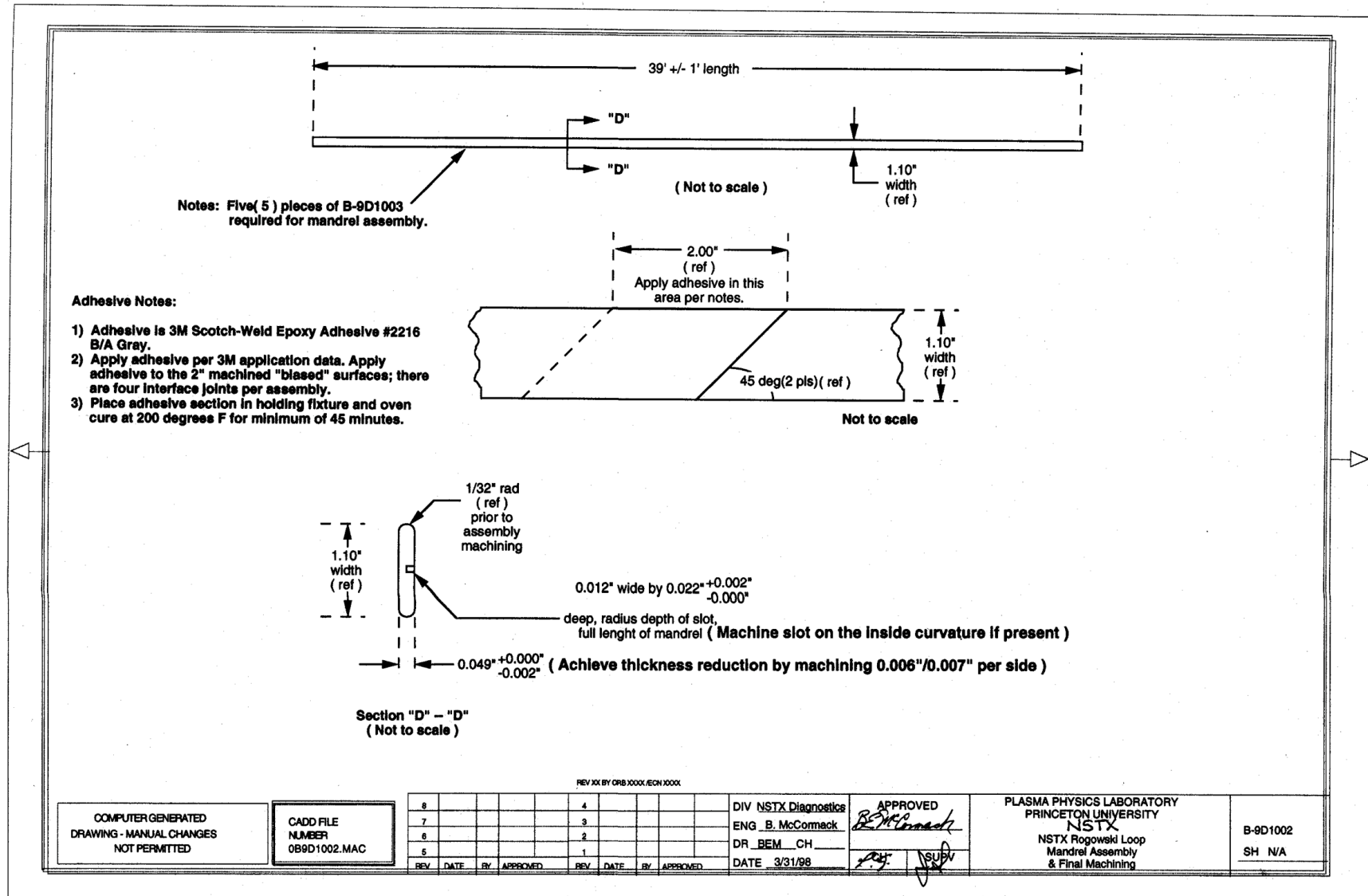
## Langmuir Probe Summary (continued)

- Status (continued)
  - Impact of upgrade on diagnostic
    - No temperature issues:
      - Carbon components similar to tile material
      - MACOR components rated at 800 °C continuous
    - No mechanical issues: Sensors and wires held in place by tiles

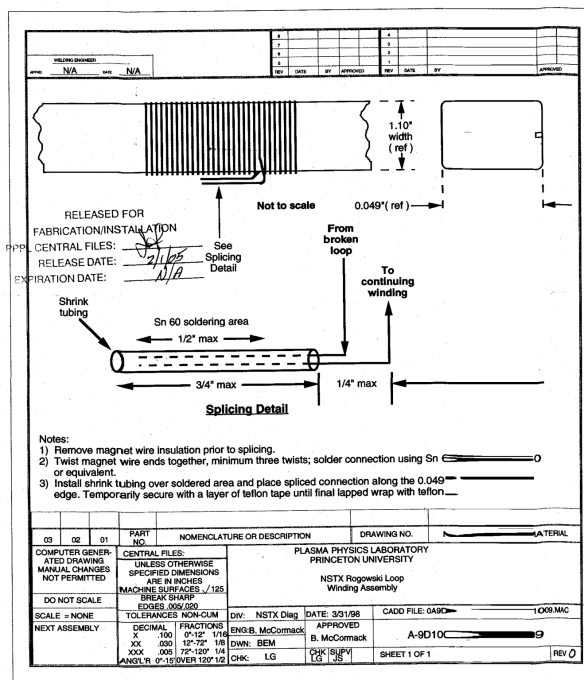
# Plasma Current Rogowski Coil Summary

- Status
  - Locations
    - Similar to placement on existing center stack
    - Consider increasing number from two to three for additional redundancy
  - Design
    - Essentially unchanged
    - Need to determine if “radial build” of larger center stack can accommodate thicker Rogowski coil for ease of mandrel fabrication
  - Documentation
    - Drawings available from archived NSTX engineering drawings
    - Statement of Work for winding available (Airex Corporation)
    - Installation procedure available

# Plasma Current Rogowski Coil Mandrel Drawing



# Plasma Current Rogowski Coil Winding Drawing



## Plasma Current Rogowski Coil Summary (continued)

- Status (continued)
  - Impact of upgrade on diagnostic
    - No temperature issues:
      - To be protected by “microtherm” insulation as on present center stack
    - No mechanical issues:
      - Coils to be held in place with Teflon tape as on present center stack

# Flux Loop Summary

- Status
  - Locations
    - Similar to placement on existing center stack
  - Design
    - Two enamel-coated wires at each location for redundancy as on existing center stack
  - Documentation
    - Installation procedure available
  - Impact of upgrade on diagnostic
    - No temperature issues:
      - To be protected by “microtherm” insulation as on present center stack
    - No mechanical issues:
      - Coils to be held in place with Kapton tape as on present center stack

## Acknowledgements

- S. Gerhardt
- H. Kugel (original sensor design)
- B. McCormack (original sensor design)
- V. Soukhanovskii
- K. Tresemer (center stack upgrade tile design)
- A. Jariwala (diagnostic layout on center stack)